MCT8329EVM Evaluation Module



ABSTRACT

This document is provided with the MCT8329 customer evaluation module (EVM) as a supplement to the MCT8329 data sheet (MCT8329 Three-Phase Sensorless-Trapezoidal BLDC Gate Driver). This user's guide details the hardware implementation of the EVM and how to setup and power the board.

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Cautions and Warnings

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1 Cautions and Warnings

Observe the following cautions and warnings as printed on the EVM board.



CAUTION

Hot Surface! Contact can cause burns. Do not touch. Please take the proper precautions when operating.

2 Introduction

The MCT8329 is a 4.5-V to 60-V, three-phase BLDC gate driver IC with code-free sensorless Trapezoidal control for motor drive applications. The MCT8329 provides three half-bridge gate drivers, each capable of driving highside and low-side N-channel power MOSFETs. The device generates the correct gate drive voltages using in internal charge pump and enhances the high-side MOSFETs using a bootstrap circuit. A trickle charge pump is included to support 100% duty cycle. The Gate Drive architecture supports peak gate drive currents up to 1-A source and 2-A sink. The MCT8329 can operate from a single power supply and supports a wide input supply range of 4.5 to 60 V. The I2C interface variant (MCT8329A1I) also provides a standard I2C interface for configuring the various device settings and reading fault diagnostic information through an external controller.

The MCT8329EVM includes an onboard FTDI chip to convert USB communication from the micro-USB connector into UART and an onboard MSP430FR2355 MCU to interface with the MCT8329. The MCT8329EVM can also provide SPI communication for the SPI variant of the MCT8329 device. There are many user-selectable jumpers, resistors, connectors, and test points to evaluate many features of the device and configure device-specific settings.

This document serves as a startup guide to supplement the MCT8329EVM. The user's guide is intended for engineers to design, implement, and validate reference hardware for the MCT8329 device.

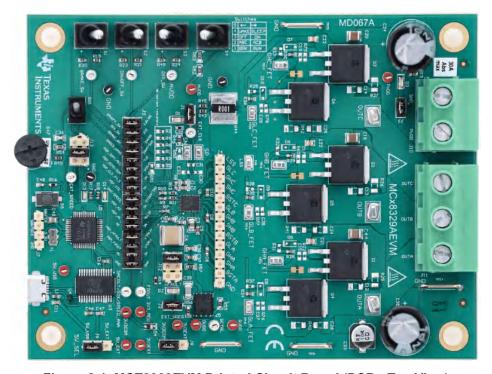


Figure 2-1. MCT8329EVM Printed Circuit Board (PCB - Top View)

www.ti.com Quick Start Guide

3 Quick Start Guide

The MCT8329EVM requires a power supply source, which has a recommended operating range from a 4.5-V to 60-V. To setup and power the EVM, follow the sequence below:

- 1. Connect motor phases to A, B, C on connector J11.
- 2. Do not turn on the power supply yet. Connect motor supply to PVDD and GND on connector J10.
- 3. Select J6 to 5V_USB and J8 to 3V3COM to power MSP430 from USB power supply.
- 4. Connect the micro-USB cable into the computer.
- 5. Turn the potentiometer fully clockwise to set the motor to zero speed upon powerup.
- 6. Flip the switch S1 to the top to configure BRAKE = RUN, switch S2 to the top to configure DRVOFF = ON, switch S3 to the bottom to configure DIR = ABC, and switch S4 to the bottom to configure to WAKE.
- 7. Flip the switch SW1 to left to configure SPEED/WAKE pin to SPEED mode and DACOUT/SOx/SPEED_ANA pin to DACOUT mode. Note that flipping the switch SW1 to right configures SPEED/WAKE pin to WAKE mode and DACOUT/SOx/SPEED_ANA pin to SPEED_ANA mode. When SW1 is flipped to right, switch S4 can be used to put the device in SLEEP or WAKE mode and potentiometer R47 can be used to apply analog voltage to the DACOUT/SOx/SPEED_ANA pin.
- 8. Select J12 to leftmost position(closer to C6) to apply AVDD to VREG.
- 9. Select J13 to middle position to apply analog voltage from potentiometer R47 to SPEED/WAKE pin.
- 10. Turn on the motor power supply.
- 11. Use the potentiometer R47 to control the speed of the motor and the switches to disable the motor driver, change the direction, or apply a brake to the motor. Optionally, use the GUI (as shown in Section 6) to monitor real-time speed of the motor, put the MCT8329 into a low-power sleep mode, and read status of the LEDs.

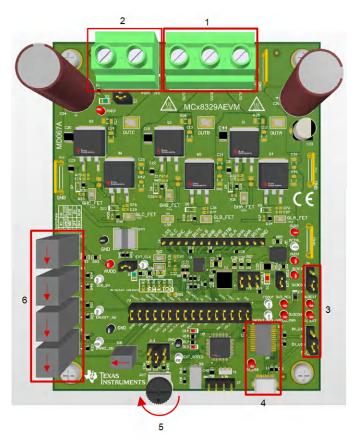


Figure 3-1. Reference for Quick Start Guide



4 Hardware and Software Overview

4.1 Hardware Connections Overview - MCT8329EVM

Figure 4-1 shows the major blocks of MCT8329EVM evaluation module. The MCT8329EVM is designed for an input supply from 4.5-V to 60-V. The MCT8329EVM includes power stage with six external N-channel power MOSFETs (Part number: CSD18536KTTT) and passive components. The MCT8329EVM also includes a current sense shunt resistor of 1 m Ω and an external N-channel MOSFET controlled by GCTRL to generate VREG.

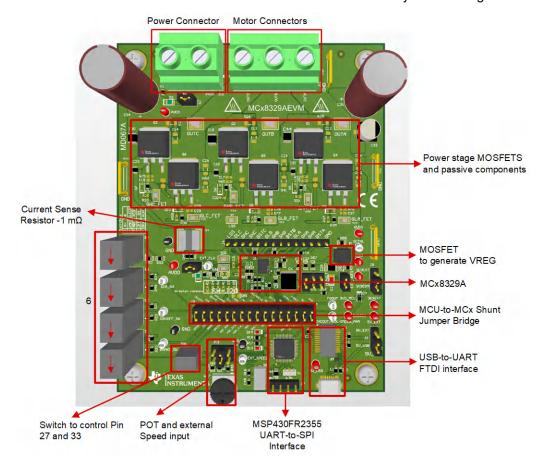


Figure 4-1. MCT8329EVM Major Hardware Blocks



4.2 Connection Details

Figure 4-2 shows the connections made to the MCT8329EVM to spin a 3-phase sensorless Brushless-DC motor.

An 4.5-V to 60-V power supply is connected to the PVDD and GND terminals on connector J10.

The three phases of the BLDC motor connect directly to the A, B, and C terminals of the screw terminal connector J11 provided on the MCT8329EVM.



Figure 4-2. Connections from Motor to MCT8329EVM

Figure 4-3 MSP430FR2355 Microcontrollershows where the micro-USB cable is plugged into the MCT8329EVM to provide communication between evaluation module and GUI. The USB data and 5 V power from the USB is converted into UART data and 3.3 V power to power the MSP430FR2355 microcontroller. The 5 V from the USB power is limited to 500 mA and the 3.3 V from the FTDI chip is limit to 30 mA. If the user wants to supply more current to these rails, then use the 5V_SEL jumper J3 and 3V3_SEL jumper J5 to connect external power rails.



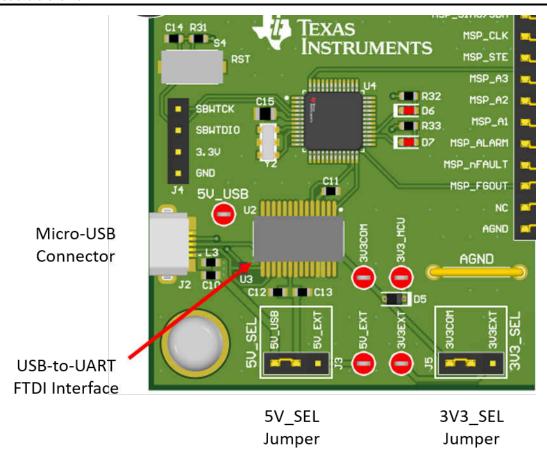


Figure 4-3. Micro-USB Connector and UART for MCT8329EVM

4.3 MSP430FR2355 Microcontroller & User Interface

The MCT8329EVM includes the MSP430FR2355 low-power MCU (as shown in Figure 4-4) to communicates via I2C with the MCT8329.

To program the MSP430FR2355, an external MSP430 FET programmer must be connected to the Spy-Bi-Wire (SBW) interface connector J4. Many MSP430 LaunchPad™ provide an onboard eZ-FET Debug Probe that can be jumper-wired to the MCT8329EVM to flash the firmware into the MSP430FR2355 microcontroller.

The user can use the Reset (RST) button at any time to reset and restart the MCU program. Two active-low LEDs, D13 and D14, can be used for debug purposes as well.

Finally, a shunt jumper bridge on the 32-pin connector J9 ties all signals between the microcontroller and MCT8329. These jumpers can be inserted or removed as needed to isolate the microcontroller from the gate driver. This allows for microcontroller signal debugging or using the MCT8329EVM as a standalone gate driver with an external microcontroller.

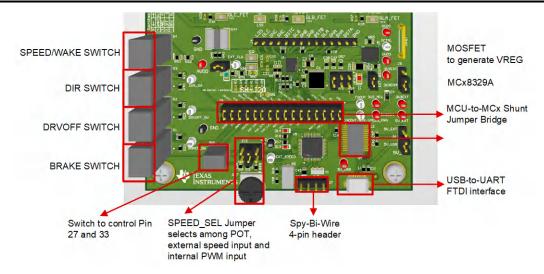


Figure 4-4. MSP430FR2355 MCU and User Interface on MCT8329EVM

4.4 LED Lights

The MCT8329EVM has 5 status LEDs implemented that provide the status of power supplies and functions of the evaluation module. By default, the VM LED and 3.3 V Buck LEDs light up when the board is powered and the program has been flashed onto the microcontroller. Table 4-1 shows LED descriptions including those that are on during power up in bold and Figure 4-5 shows the locations of the LEDs.

Table 4-1. Description of MCT8329EVM LEDs (default in bold after powerup)

Designator	Name	Color	Description		
D1	AVDD Regulator	Green	Lights up when AVDD is turned ON.		
D2	nFAULT	Red	Lights up when fault condition has occurred on MCT8329		
D3	PVDD	Green	Lights up when voltage is applied on PVDD.		
D13	MSP_LED1	Red	Used for UART or debugging		
D14	MSP_LED2	Red	Used for UART or debugging		

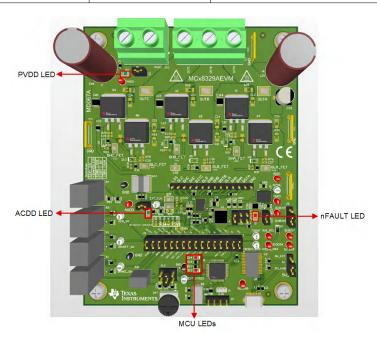


Figure 4-5. MCT8329EVM LEDs



4.5 User-Configurable Settings

The MCT8329EVM includes a variety of user-selectable jumpers, switches, and resistors on the entirety of the evaluation board to configure settings. Table 4-2 summarizes all of these configurable settings.

Table 4-2. Description of User-Selectable Settings on MCT8329EVM (Default in Bold)

Designator	Setting Name	Description	Layer	Position	Function
J8	3V3_SEL	Select 3.3 V for MCU power	Тор	J8 = 3V3EXT	External
				J8 = 3V3COM	From FTDI (30 mA)
J6	5V_SEL	Select 5 V for FTDI power	Тор	J6 = 5V_EXT	External
				J6 = 5V_USB	From USB power (500 mA)
J13	SPEED_SEL	Selects SPEED input source	Тор	J13 = EXT	External EXT_SPEED test point
				J13 = POT	From Potentiometer R47.
				J13 = INT_PWM	From internal PWM. PWM Duty cycle can be varied by rotating the POT R47.
J9	MSP to MCx Shunt	Connects signals from MCU and user	Тор	DRVOFF_SW	DRVOFF
	jumper bridge	switches to MCT8329 when jumpers are inserted		DIR_SW	DIR
		are mooned		BRAKE_SW	BRAKE
				SPEED_WAKE	SPEED/WAKE
				MSP_POCI/SCL	SCL
				MSP_PICO/SDA	SDA
				MSP_CLK	NC
				MSP_STE	NC
				DAC/SPEED	DAC/SPEED
				MSP_A2	NC
				MSP_A1	GCTRL
				NC	NC
				MSP_nFAULT	nFAULT
				MSP_FGOUT	FGOUT
				NC	NC
				GND	GND
J12	VREG_SEL	Selects VREG power supply	Тор	Left position	VREG powered by AVDD
				Middle position	VREG powered externally.
				Right position	VREG powered by MOSFET Q7
J1	AVDD LED	Connects AVDD LED to 3.3 V pull up.	Тор	Connected	D1 lights up when AVDD is turned ON.
J2	nFAULT LED	Connects nFAULT LED to 3.3 V pull up.	Тор	Connected	D2 lights up when nFAULT is Pulled low.
J3	PVDD LED	Connects PVDD LED to 3.3 V pull up.	Тор	Connected	D3 lights up when voltage is applied to PVDD.
S1	BRAKE	Turns on all low-side MOSFETs	Тор	Bottom	Brake enabled
				Тор	Brake disabled



Table 4-2. Description of User-Selectable Settings on MCT8329EVM (Default in Bold) (continued)

Designator	Setting Name	Description	Layer	Position	Function
S2	DRVOFF	Disables gate drivers	Тор	Bottom	MCT8329 disabled
				Тор	MCT8329 enabled
S3	DIR	Controls direction of motor rotation.	Тор	Bottom	ABC
				Тор	ACB
S4	SPEED/WAKE	Pulls SPEED/WAKE pin to AVDD and GND	Тор	Bottom	SPEED/WAKE pin pulled to AVDD.
				Тор	SPEED/WAKE pin pulled to GND.
SW1	N/A	Configure SPEED/WAKE pin to SPEED mode and DACOUT/SOx/ SPEED_ANA pin	Тор	Left	Configure SPEED/ WAKE pin to SPEED mode and DACOUT/SOx/ SPEED_ANA pin to DACOUT mode.
				Right	Configure SPEED/ WAKE pin to WAKE mode and DACOUT/SOx/ SPEED_ANA pin to SPEED_ANA mode.



Hardware Setup Www.ti.com

5 Hardware Setup

The hardware required to run the motor is the MCT8329EVM, a Micro-USB cable, and a power supply with a DC output from 4.5-V to 60-V. Follow these steps to start up the MCT8329EVM:

- 1. Connect the DC power supply to header J10. Connect to PVDD and GND.
- 2. Apply user configurable jumper settings. See Section 4.5 section for more information.
- 3. Flash program into the MCU as described in Section 4. Launch the GUI in GUI Composer and disconnect the 4-pin JTAG connections.
- 4. Connect a Micro-USB cable to the MCT8329EVM and computer.
- 5. Turn on the power supply and power up the PCB.

If using the MCT8329EVM with an external microcontroller, remove all shunt jumpers from jumper bridge J9. Connect with external jumpers to the left side of the jumper bridge from the external MCU.



6 MCT8329 GUI Application

The MCT8329EVM includes a USB-UART interface, using a MSP430FR2355 microcontroller, that serves as a communication bridge between a host PC and the MCT8329 device for configuring various device settings and reading fault diagnostic information. A MCT8329 GUI is available to interface with and configure the MCT8329 using this communication interface.

Access the MCT8329A GUI through the TI Cloud Gallery.

6.1 Running the GUI

The MCT8329A GUI can be run directly inside a web browser (supported in Google Chrome and Firefox).

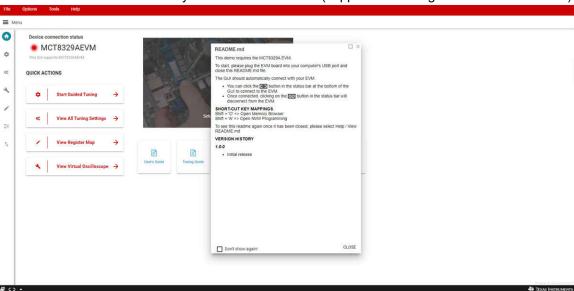


Figure 6-1. MCT8329A GUI

Once the GUI is loaded, follow the step-by-step Guided Tuning section of the GUI to configure the device.

6.2 Offline Installer

Alternatively, the MCT8329A GUI can be downloaded and installed offline using the download feature in the TI Cloud Gallery. Here are the steps to install MCT8329A GUI offline:

- 1. Go to dev.ti.com/gallery and search for MCT8329.
- 2. Place the cursor on the download (down arrow) button.
- 3. Select the appropriate operating system (Linux, MAC or Windows) and click the operating system. (Note: Do not click the runtime)
- 4. A zip file starts to downloads. Unzip the file and click the .exe file to install the offline MCT8329A GUI.



7 MSP430FR2355 Interface Firmware

The MSP430FR2355 on the MCT8329EVM comes pre-programmed with the firmware necessary for communicating with the PC GUI and the MCT8329. In order to reprogram or flash custom code on the MSP430FR2355, you will need an external MSP430 LaunchPad™that includes the eZ-FET Debug Probe. In this example, we use the MSP-EXP430FR2355 LaunchPad Development Kit to provide the debug probe. Follow the steps below to download the code for the MCT8329EVM to use with the GUI.

7.1 Downloading Code Composer Studio and Importing MSP430FR2355 Interface Firmware Code

- 1. Extract the "MCT8329EVM_MSP430FR2355_Firmware_GUI.zip" to a location on the computer.
- Download the latest version of Code Composer Studio. This download sets up a ti folder in the directory C:\ti.
 - a. Accept all agreements, default install locations, and hit Next to proceed through menus.
 - b. In the *Select Components* window, make sure to check *MSP430 Low-Power MCUs* to install the required packages for the MSP430 LaunchPad Evaluation Kits.
- After installing, run CCS and select a folder or the default to use as the Workspace to store any new
 projects. The location and naming convention can be changed based on the user's preference. Click the OK
 button to accept.
- 4. In CCS, click on the Project tab and select *Import CCS Projects*. Click on *Browse*.
- 5. Select the MCT8329EVM MSP430FR2355 Firmware GUI folder installed from step 1.
- 6. Import the project MCT8329EVM_MSP430FR2355_Firmware_GUI into your workspace as shown in Figure 7-1.

```
ø
msp430 - MCT8316Z0R GUI Code/Source/MCT8316Z0R GUI Code.c - Code Composer Studio
//Preset Initializations
PwmSel = 1;
GUIComm_sendUInt8("num_pol", 7, 4);
GUIComm_sendBool("nsleep", 6, 0);
                                                                                                                       __bis_SR_register(LPM0_bits | GIE); // Enter LPM0 w/interrupt
__enable_interrupt();
                                                                                                                       while (1)
                                                                                                                               count++;
ADCCTL0 |= ADCENC | ADCSC;
                                                                                                                                                                                          // Sampling and conversion start
                                                                                                                               //ADC-PWM flag
if (adc_flag == true){
   adc_flag = false;
   if (PwmSel == 1)

☐ GUIComm_JSON.c

☐ MCT8316Z0R_GUI_Code.c

                                                                                                                                           TB1CCR1=(int)(ADC_Result/10);
                                                                                                                                            TB1CCR1=(int)(PwmDuty*4.0);
                                                                                                                                      old_PWM_DC = PWM_DC;
                                                                                                                                     //PMM_DC = (float)((float)(TBICCRI)*100.0)/(float)(TBICCR0));
PMM_DC = (float)((float)(ADC_Result)*1.0175/40.96);
if (PMM_DC > 100.0)
                                                                                                                                    PWM_DC = 100.0;
                                                                                                                                     if (PWM_DC != old_PWM_DC)
{
                                                                                                                                            GUIComm_sendInt16("pwm_dc", 6, (_q5)(PWM_DC*32.0));
                                                                                                                             //FGOUT and Notor Speed
if (fgout_flag == true)
f (fgout_flag = state;
fgout_flag = false;
fGOUT_freq = (flost)(32500.0"(flost)(FGOUT_DIV)/(flost)(diff));
commSpeed = (flost)(1(211.0"FGOUT_freq)/(flost)(bumPoles));
GUIComm_sendInti6("fgout", 5, (q7)(FGOUT_freq*129.5));
GUIComm_sendInti6("fgout", 3, (uinti6_t)(commSpeed));
       OutOfBox_MSP-EXP430FR2355

    RgbLedMixing_LPM_FR2433
    RgbLedMixing_LPM_FR2433_GUI

                                                                                                                                      GUIComm_sendBool("nsleep", 6, 1);
P3OUT |= BIT2;
```

Figure 7-1. MSP430FR2355 Interface Firmware Code in Code Composer Studio



7.2 Using the eZ-FET to Program the MSP430FR2355

The eZ-FET Debug Probe on the MSP430FR2355 LaunchPad uses a SPI-by-Wire JTAG interface to program the MSP430FR2355 MCU on the MCT8329EVM. Consult the MSP430 LaunchPad Development Kits for MSP430 LaunchPads that include an onboard eZ-FET Debug Probe.

- 1. Remove the GND, 3V3, SBWTDIO, and SBWTCK jumpers from the MSP430 LaunchPad.
- 2. Connect the top pins on the eZ-FET side of the LaunchPad of the GND, 3V3, SBWTCK, and SBWTDIO signals to their respective pins on J7 of the MCT8329EVM as shown in Table 7-1 and Figure 7-2.
- 3. Connect a micro-USB cable to the MSP430 LaunchPad and the PC.
- 4. Click on the Build Project icon or *Ctrl* + *B* to verify that the project builds successfully. Accept any updates if needed from the Console.
- 5. Click on Debug Project to set up a debug session and press the Play button to run the code.
- 6. Stop the debug session, close Code Composer Studio, disconnect the SPI-by-Wire jumpers, and unplug the micro-USB cable from the MSP430 LaunchPad.

Table 7-1. SPY-BI-Wire Connections Needed to Program MSP430FR2355

- <u></u>				
MSP430 LaunchPad (eZ-FET Debug Probe Side) (J101)	MCT8329EVM 4-pin SPI-by-Wire Header (J7)			
GND	GND			
3V3	3.3 V			
SBWTDIO	SBWTDIO			
SBWTCK	SBWTCK			

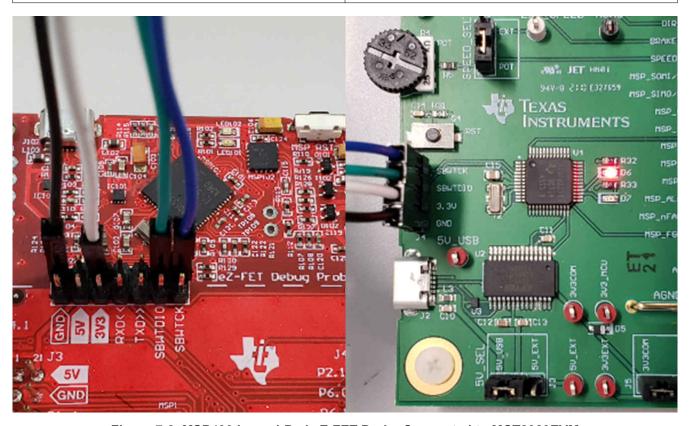


Figure 7-2. MSP430 LaunchPad eZ-FET Probe Connected to MCT8329EVM

Schematics www.ti.com

8 Schematics

8.1 Main Supply

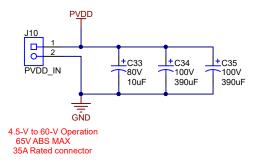


Figure 8-1. Main Supply

8.2 Connectors and Interface

8.3 USB to UART

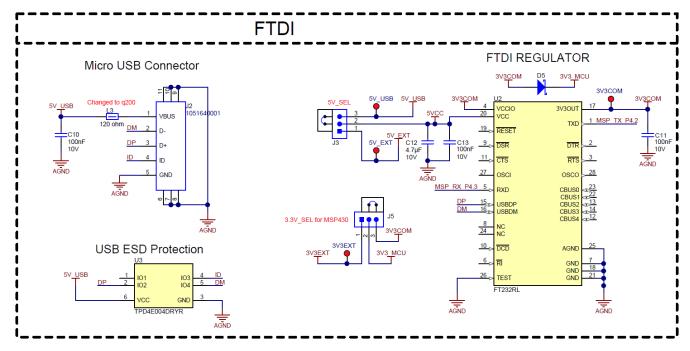


Figure 8-2. USB to UART Schematic

www.ti.com Schematics

8.4 MCU Programming and Debug

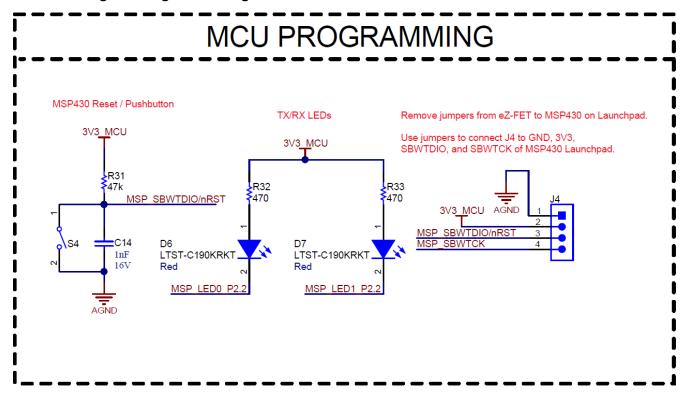


Figure 8-3. MCU Programming and Debug Schematic

8.5 MSP430FR2355 MCU

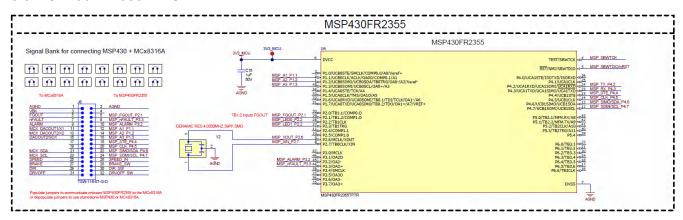


Figure 8-4. MSP430FR2355 MCU Schematic

Schematics www.ti.com

8.6 MCT8329 3-Phase Sensorless Trapezoidal Gate Driver

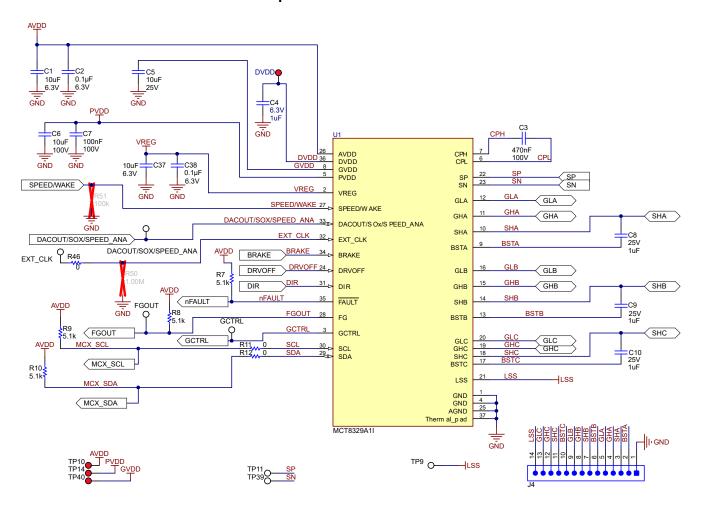


Figure 8-5. MCT8329A 3-Phase Sensorless Trapezoidal Gate Driver Schematic

8.7 Status LEDs

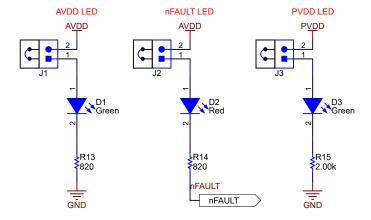


Figure 8-6. Status LEDs Schematic

www.ti.com Schematics

8.8 Switches and Speed Input

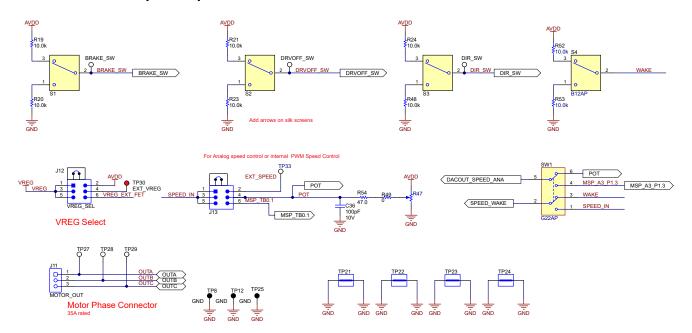


Figure 8-7. Switches and Speed Input

INSTRUMENTS Revision History www.ti.com

9 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Cł	hanges from Revision * (December 2022) to Revision A (May 2023)	Page
•	Updated the quality of the images throughout the document	1
•	Changed all instances of legacy terminology to POCI and PICO where SPI is mentioned	8

STANDARD TERMS FOR EVALUATION MODULES

- Delivery: TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or
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Evaluation Kits are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.

User shall operate the Evaluation Kit within TI's recommended guidelines and any applicable legal or environmental requirements as well as reasonable and customary safeguards. Failure to set up and/or operate the Evaluation Kit within TI's recommended guidelines may result in personal injury or death or property damage. Proper set up entails following TI's instructions for electrical ratings of interface circuits such as input, output and electrical loads.

NOTE:

EXPOSURE TO ELECTROSTATIC DISCHARGE (ESD) MAY CAUSE DEGREDATION OR FAILURE OF THE EVALUATION KIT; TI RECOMMENDS STORAGE OF THE EVALUATION KIT IN A PROTECTIVE ESD BAG.

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3.1 United States

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3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types lated in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

3.3 Japan

- 3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
 - https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-delivered-in-japan.html
- 3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above. User will be subject to penalties of Radio Law of Japan.

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- 1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用 いただく。
- 2. 実験局の免許を取得後ご使用いただく。
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西新宿三井ビル

- 3.3.3 Notice for EVMs for Power Line Communication: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_02.page 電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-for-power-line-communication.html
- 3.4 European Union
 - 3.4.1 For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

- 4 EVM Use Restrictions and Warnings:
 - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
 - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
 - 4.3 Safety-Related Warnings and Restrictions:
 - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
 - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
 - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
- 5. Accuracy of Information: To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.

6. Disclaimers:

- 6.1 EXCEPT AS SET FORTH ABOVE, EVMS AND ANY MATERIALS PROVIDED WITH THE EVM (INCLUDING, BUT NOT LIMITED TO, REFERENCE DESIGNS AND THE DESIGN OF THE EVM ITSELF) ARE PROVIDED "AS IS" AND "WITH ALL FAULTS." TI DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, REGARDING SUCH ITEMS, INCLUDING BUT NOT LIMITED TO ANY EPIDEMIC FAILURE WARRANTY OR IMPLIED WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF ANY THIRD PARTY PATENTS, COPYRIGHTS, TRADE SECRETS OR OTHER INTELLECTUAL PROPERTY RIGHTS.
- 6.2 EXCEPT FOR THE LIMITED RIGHT TO USE THE EVM SET FORTH HEREIN, NOTHING IN THESE TERMS SHALL BE CONSTRUED AS GRANTING OR CONFERRING ANY RIGHTS BY LICENSE, PATENT, OR ANY OTHER INDUSTRIAL OR INTELLECTUAL PROPERTY RIGHT OF TI, ITS SUPPLIERS/LICENSORS OR ANY OTHER THIRD PARTY, TO USE THE EVM IN ANY FINISHED END-USER OR READY-TO-USE FINAL PRODUCT, OR FOR ANY INVENTION, DISCOVERY OR IMPROVEMENT, REGARDLESS OF WHEN MADE, CONCEIVED OR ACQUIRED.
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 - 8.1 General Limitations. IN NO EVENT SHALL TI BE LIABLE FOR ANY SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL, OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF THESE TERMS OR THE USE OF THE EVMS, REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. EXCLUDED DAMAGES INCLUDE, BUT ARE NOT LIMITED TO, COST OF REMOVAL OR REINSTALLATION, ANCILLARY COSTS TO THE PROCUREMENT OF SUBSTITUTE GOODS OR SERVICES, RETESTING, OUTSIDE COMPUTER TIME, LABOR COSTS, LOSS OF GOODWILL, LOSS OF PROFITS, LOSS OF SAVINGS, LOSS OF USE, LOSS OF DATA, OR BUSINESS INTERRUPTION. NO CLAIM, SUIT OR ACTION SHALL BE BROUGHT AGAINST TIMORE THAN TWELVE (12) MONTHS AFTER THE EVENT THAT GAVE RISE TO THE CAUSE OF ACTION HAS OCCURRED.
 - 8.2 Specific Limitations. IN NO EVENT SHALL TI'S AGGREGATE LIABILITY FROM ANY USE OF AN EVM PROVIDED HEREUNDER, INCLUDING FROM ANY WARRANTY, INDEMITY OR OTHER OBLIGATION ARISING OUT OF OR IN CONNECTION WITH THESE TERMS, , EXCEED THE TOTAL AMOUNT PAID TO TI BY USER FOR THE PARTICULAR EVM(S) AT ISSUE DURING THE PRIOR TWELVE (12) MONTHS WITH RESPECT TO WHICH LOSSES OR DAMAGES ARE CLAIMED. THE EXISTENCE OF MORE THAN ONE CLAIM SHALL NOT ENLARGE OR EXTEND THIS LIMIT.
- 9. Return Policy. Except as otherwise provided, TI does not offer any refunds, returns, or exchanges. Furthermore, no return of EVM(s) will be accepted if the package has been opened and no return of the EVM(s) will be accepted if they are damaged or otherwise not in a resalable condition. If User feels it has been incorrectly charged for the EVM(s) it ordered or that delivery violates the applicable order, User should contact TI. All refunds will be made in full within thirty (30) working days from the return of the components(s), excluding any postage or packaging costs.
- 10. Governing Law: These terms and conditions shall be governed by and interpreted in accordance with the laws of the State of Texas, without reference to conflict-of-laws principles. User agrees that non-exclusive jurisdiction for any dispute arising out of or relating to these terms and conditions lies within courts located in the State of Texas and consents to venue in Dallas County, Texas. Notwithstanding the foregoing, any judgment may be enforced in any United States or foreign court, and TI may seek injunctive relief in any United States or foreign court.

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